

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model : MI0570ET-52CP

This module uses RoHS material

For Customer's Acceptance:

Customer		
Approved		
Comment		

	Revision	1.0
related to mechanical, electrical or raw materials, Multi- Inno should get the formal approval from end customer	Engineering	
formet Contraction of the second seco	Date	2015-11-11
	Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REVISED PAGE NO.
1.0	2015-11-11	First Release	



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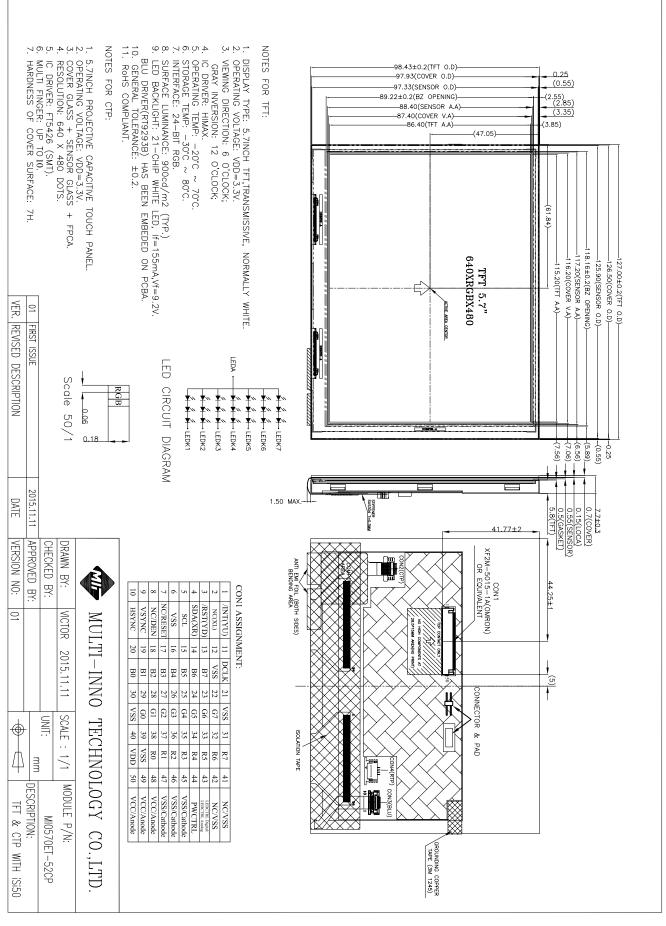
■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	5.7	Inch
Viewing direction	6:00(without image inversion and least brightness	O' Clock
	change)	
Gray scale inversion direction	12:00(contrast peak located at)	O' Clock
$LCM(W \times H \times D)$	127.0×98.43×7.7	mm ³
Active area (W×H)	115.2×86.4	mm ²
Pixel pitch (W×H)	0.18×0.18	mm ²
Number of dots	640 (RGB) × 480	/
Driver IC	HX8250A+HX8678B	/
Backlight type	21 LEDs	/
Interface type	24-bit RGB	/
Color depth	16.7M	/
Pixel configuration	R.G.B vertical stripe	/
Top polarizer surface treatment	Glare	/
Input voltage	3.3	V
With/Without TSP	With CTP	/
TP surface treatment	TBD	/
Weight	TBD	g

Note 1: RoHS compliant;

Note 2: LCM weight tolerance: \pm 5%.







■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage(logic)	VDD	-0.5	5.0	V
Power voltage(backlight driver)	VCC	-0.3	6.0	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Тѕт	-30	80	°C

ELECTRICAL CHARACTERISTICS

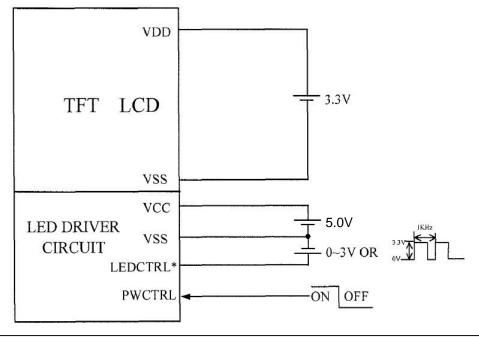
Parameter	Symbol	Min	Тур	Max	Unit	Condition
Power supply voltage	VDD	3.0	3.3	3.6	V	
LCD power current	IDD	-	TBD	-	mA	Black pattern
Input voltage ' H ' level	Vih	0.7VDD	-	VDD	V	Note 1
Input voltage ' L ' level	Vill	0	-	0.3VDD	V	INOLE I

Note 1:DCLK,DE,R0-R7,G0-G7,B0-B7.

■ BACKLIGHT CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Power voltage(driver)	VCC	-	5.0	5.5	V	
Current for driver	IVCC	-	TBD	-	mA	
Diming control for LED	LEDCTRL ANALOG	0	-	3.0	V	
backlight	LEDCTRL	-	3.3	-	V	PWM Signal
	DIGITAL	200	1K	20K	Hz	Note3
Power enable	PWCTRL	-	3.3	-	V	Power On
Voltage for LED backlight	VF	-	9.2	-	V	Note1
Current for LED backlight	IF	-	155	-	mA	
LED life time	-	30,000	50,000	-	Hr	Note2

Note1: Power supply for LCM.



* The LEDCTRL can alternatively be used with a PWM.

Note 2: The LED supply voltage is defined by the number of LED at Ta=25°C and IF=155mA.

Note 3: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IF=155mA. The LED life time could be decreased if operating IF is lager than 155mA.

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	Note	
Response	time	Tr+Tf		-	50	-	ms	FIG 1.	4	
Contrast r	atio	Cr	θ=0°	200	300	-		FIG 2.	1	
Luminar uniform		δ WHITE	Ø=0° Ta=25℃	70	80	-	%	FIG 2.	3	
Surface Lum	inance	Lv		-	900	-	cd/m ²	FIG 2.	2	
			$\emptyset = 90^{\circ}$	50	60	-	deg	FIG 3.		
Viewing angl	Viewing angle range		$\emptyset = 270^{\circ}$	30	40	-	deg	FIG 3.	6	
viewing angi			$\emptyset = 0^{\circ}$	60	70	-	deg	FIG 3.		
			$\emptyset = 180^{\circ}$	60	70	-	deg	FIG 3.		
	Red	X		0.565	0.615	0.665				
	Keu	у		0.310	0.360	0.410				
	Green	X	θ=0°	0.295	0.345	0.395				
CIE (x, y)	Ulteri	у	0−0 Ø=0°	0.490	0.540	0.590		FIG 2.	5	
chromaticity	Blue	X	2000 Ta=25℃	0.098	0.148	0.198		110 2.	5	
	Diue	у	1a-23C	0.056	0.106	0.156				
	White	X		0.259	0.309	0.359				
	wille	у		0.270	0.320	0.370				

■ELECTRO-OPTICAL CHARACTERISTICS

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

Contrast Ratio = <u>Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)</u> Average Surface Luminance with all black pixels (P1, P2, P 3, P4, P5)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Note 3. The uniformity in surface luminance δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance. For more information see FIG 2.

δ WHITE =Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

- Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.
- Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.
- Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.



Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

FIG. 1 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

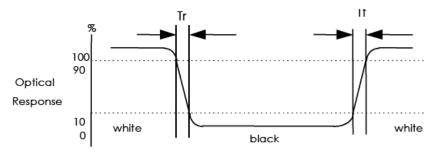
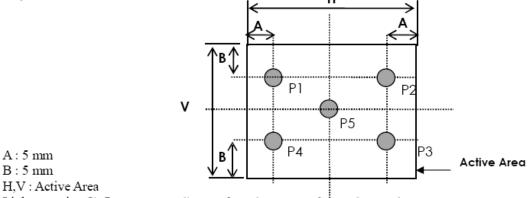
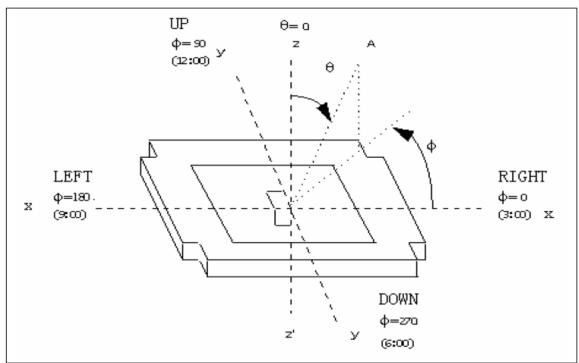


FIG. 2 Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity



Light spot size \emptyset =7mm, 500mm distance from the LCD surfade to detector lens measurement instrument is TOPCON's luminance meter BM-5

FIG. 3 The definition of viewing angle





■ INTERFACE DESCRIPTION

Pin No.	Symbol	I/O	Function	Remark
1	/INT(YU)	Ι	Interrupt signal to host from CTP	СТР
2	NC(XL)	-	No connection	СТР
3	/RST(YD)	Ι	Reset.active low	СТР
4	SDA(XR)	Ι	I2C data signal	СТР
5	SCL	Ι	I2C clock signal	СТР
6	VSS	Р	Power ground	
7	NC/RESET	Ι	No connection(Default)/TFT Reset	
8	NC/DEN	Ι	No connection(Default)/Data enable	
9	VSYNC	Ι	Vertical SYNC	
10	HSYNC	Ι	Horizontal SYNC	
11	DCLK	Ι	Clock signals; Latching data at rising edge	
12	VSS	Р	Power ground	
13	B7	Ι	Blue data	
14	B6	Ι	Blue data	
15	B5	Ι	Blue data	
16	B4	Ι	Blue data	
17	B3	Ι	Blue data	
18	B2	Ι	Blue data	
19	B1	Ι	Blue data	
20	B0	Ι	Blue data	
21	VSS	Р	Power ground	
22	G7	Ι	Green data	
23	G6	Ι	Green data	
24	G5	Ι	Green data	
25	G4	Ι	Green data	
26	G3	Ι	Green data	
27	G2	Ι	Green data	
28	G1	Ι	Green data	
29	GO	I	Green data	
30	VSS	Р	Power ground	
31	R7	I	Red data	
32	R6	I	Red data	
33	R5	Ι	Red data	
34	R4	Ι	Red data	
35	R3	Ι	Red data	
36	R2	Ι	Red data	
37	R1	I	Red data	
38	RO	I	Red data	
39	VSS	Р	Power ground	
40	VDD	Р	Power supply for logic	



41	NC/VSS	-	No connection(Default)/power ground	
42	NC/VSS	-	No connection(Default)/power ground	
43	LEDCTRL digital/ LEDCTRL analog	Ι	Brightness controls for LED backlight digital (PWM) default / Brightness controls for LED backlight analog.	Backlight
44	PWCTRL	Ι	PWCTRLREMARKLogic levelHH=3.3V, L=0VLPower off	Backlight
45	VSS/Cathode	Р	Power ground (default)/ Power for LED backlight cathode using external LED power supply	Backlight
46	VSS/Cathode	Р	Power ground (default)/ Power for LED backlight cathode using external LED power supply	Backlight
47	VSS/Cathode	Р	Power ground (default)/ Power for LED backlight cathode using external LED power supply	Backlight
48	VCC/Anode	Р	Power supply for LED driver (default) / Power for LED backlight anode using external LED power supply	Backlight
49	VCC/Anode	Р	Power supply for LED driver (default) / Power for LED backlight anode using external LED power supply	Backlight
50	VCC/Anode	Р	Power supply for LED driver (default) / Power for LED backlight anode using external LED power supply	Backlight

I: input, O: output, P: Power

Note1: SYNC AND SYNC-DE MODE SETTING

SYNC MODE: HSYNC / VSYNC AND DCLK ARE NECESSARY SYNC-DE MODE: HSYNC / VSYNC, DEN AND DCLK ARE NECESSARY.

Note 2: SYNC Mode Default



■ APPLICATION NOTES

1. INTERFACE SPECIFICATIONS

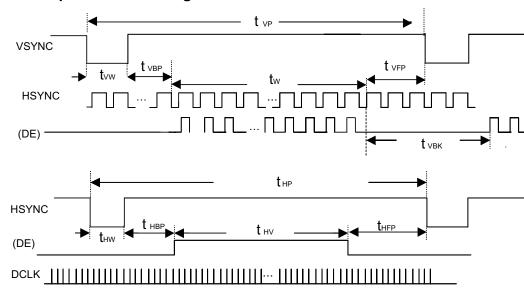
1.1 SYNC mode Input signal characteristics

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Remarks
Clock Period	t _{CLK}	33	40	43	ns	
Clock Frequency	f _{ськ}	23	25	30	MHz	
Clock Low Level Width	t _{wcL}	6	-	-	ns	
Clock High Level Width	t _{wcн}	6	-	-	ns	
Clock Rise, Fall Time	t_t_t	-	-	3	ns	
HSYNC Period	t _{HP}	750	800	900	t _{CLK}	
HSYNC Pulse Width	t _{HW}	5	30	-	t _{ськ}	
HSYNC Front Porch	t _{HFP}	1	16	116	t _{ськ}	
HSYNC Back Porch	t _{HBP}	1	114	139	t _{CLK}	
HSYNC Width + Back Porch	t _{HW} +t _{HBP}	144	144	144	t _{сLK}	
Horizontal Blank	t _{нвк}	1	160	260	t _{cLK}	
Horizontal Valid	t _{HV}	640	640	640	t _{сLK}	
VSYNC Period	t _{vP}	515	525	560	t _{HP}	
VSYNC Pulse Width	t _{vw}	1	3	5	t _{HP}	
VSYNC Front Porch	t _{vFP}	1	10	45	t _{HP}	
VSYNC Back Porch	t _{vBP}	30	32	34	t _{HP}	
VSYNC Width + Back Porch	t _{vw} +t _{vbp}	35	35	35	t _{сLK}	
Vertical Blank	t _{vвк}	35	45	80	t _{HP}	
Vaild data Width	t _w	480	480	480	t _{HP}	
Data Setup Time	t _{DS}	5	-	-	ns	
Data Hold Time	t _{DH}	10	-	-	ns	

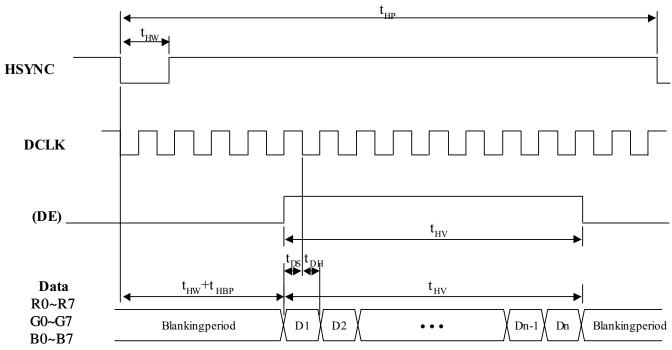
Note: (1) tHBK = tHFP + tHW + tHBP



1.1.1 SYNC mode timing waveform 1.1.1.1 Input vertical timing



Remark : If SYNC mode is used, please fix DE signal to low, DE timing waveform is for reference only.



1.1.1.2 Input horizontal timing

Remark : If SYNC mode is used, please fix DE signal to low, DE timing waveform is for reference only.

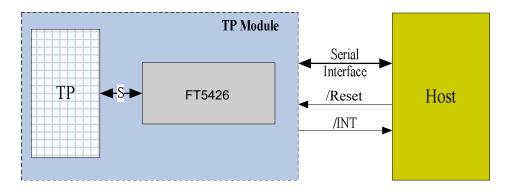


CTP SPECIFICATIONS

1. GENERAL SPECIFICATIONS

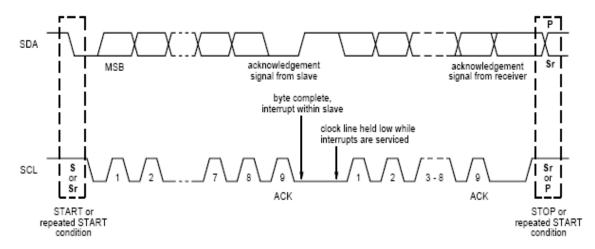
Item	Specification	Unit
Туре	Projective capacitive type touch panel	
Strueture	Cover glass+Sensor glass+FPCA	
Input mode	Human's finger	
Finger	Up to 10	
Resolution	640 x 480	dots
Cover viewing area	116.2(W) x 87.4(H)	mm
Sensor Active Area	117.2(W) x 88.4(H)	mm
Hardness	7H	Pencil hardness
Driver IC	FT5426(SMT)	/

2. BLOCK DIAGRAM

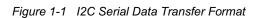


3. CTP TIMING

The I2C is always configured in the Slave mode. The data transfer format is shown in Figure 1-1.







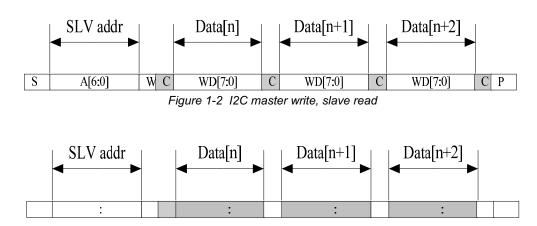


Figure 1-3 I2C master read, slave write

Table 1-1 lists the meanings of the mnemonics used in the above figures.

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address A[6:4]: 3'b011 A[3:0]: data bits are identical to those of I2CCON[7:4] register.
W	1'b0: Write
R	1'b1: Read
С	ACK
Р	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

Table 1-1 Mnemonics Description

I2C Interface Timing Characteristics is shown in Table 1-2.

Table 1-2 I2C Timing Characteristics

Parameter	Unit	Min	Max
SCL frequency		0	400
Bus free time between a STOP and START condition		4.7	\
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup Time for STOP condition	us	4.0	\

Note: More information pls refer to IC spec and application note.



RELIABILITY TEST

No.	Test Item	Test Condition	
1	High Temperature Storage	80 ± 2 °C/240hours	
2	Low Temperature Storage	-30 ± 2 °C/240hours	
3	High Temperature Operating	$70\pm2^{\circ}C/240$ hours	
4	Low Temperature Operating	-20±2°C/240hours	
5	Temperature Cycle	$\begin{array}{c} -30 \pm 2^{\circ} \mathbb{C} \sim 25 \sim 80 \pm 2^{\circ} \mathbb{C} \times 10 \text{ cycles} \\ (30 \text{ min.}) (5 \text{ min.}) (30 \text{ min.}) \end{array}$	
6	Damp Proof Test	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%$ RH/240hours	
7	Vibration Test	Frequency: 10Hz~55Hz Amplitude of vibration : 1.5mm Sweep time: 12 min X,Y,Z 2 hours for each direction.	
8	Packing drop test	According to ISTA 1A 2001	
9	Electrical static discharge	Air: ±8KV 150pF/330Ω 5 times	
		Contact: ±4KV 150pF/330Ω5 time	



■ INSPECTION CRITERION

c c	UTGOING QUALITY STANDARD	PAGE 1 OF 5				
TITLE:FUNCTIONAL 7	TEST & INSPECTION CRITERIA					
This specification is 1	This specification is made to be used as the standard acceptance/rejection criteria for TFT module.					
-	MIL-STD-105D lity level (AQL)					
Minor defect: A	QL=1.50					
2. Inspection conditio	n					
 2.1 Ambient conditions: a. Temperature: Room temperature 25± 5°C b. Humidity: (60± 10) %RH c. Illumination: Single fluoresœnt lamp non-directive (300 to 700 Lux) 2.2 Viewing distance: The distance between the LCD and the inspector' s eyes shall be at least 35± 5cm. 2.3 Viewing Angle U/D: 45° /45°, L/R: 45° /45° 						
	45° 45° 35cm~	40cm CD Panel				





TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA

3. Inspection standards

MIF

Defects are classified as majot defects and minor defects according to the degree of defectiveness defined herein.

3.1 Major defect

Item No	Items to be inspected	Inspection Standard	
3.1.1	All functional defects	 No display Display abnormally Short circuit line defect 	
3.1.2	Missing	Missing function component	
3.1.3	Crack	Glass crack	

3.2 Minor defect

Item No	Items to be inspected	Inspection standard	
Spot Defect Including		For dark/white spot is defined $\varphi = (\mathbf{x} + \mathbf{y}) / 2$ $\mathbf{x} + \mathbf{y} / 2$ $\mathbf{x} + \mathbf{y} / \mathbf{x}$	
	Black spot	Size $\phi(mm)$	Acceptable Quantity
3.2.1	White spot Pinhole	φ ≤0.20	Ignore
	Foreign particle Polarizer dirt	0.20 < φ≤ 0.50	3
		0.50<φ	Not allowed



LE:FUN	CTIONAL TEST & II	NSPECTION CRITERIA	
	Line Defect Including	Define:	Vidth
3.2.2	Black line White line Scratch	Width(mm) Length(mm)	Acceptable Quantity
	Scraten	W≤0.02	Ignore
		0.02 < w≤0.05 L≤5.0	4
		0.05 < W	Not allowed
1 2 2 2 2 I		Size $\phi(mm)$	Acceptable Quantity
		φ ≤0.25	Ignore
	Polarizer Dent/Bubble	0.25<φ≤0.5	3
		0.5< φ	0
		Bright and Black dot def	and
3.2.4	Electrical Dot Defect	Inspection pattern: Full and blue screens	white, Full black, Red, green
		Item	Acceptable Quantity
		Black dot defect	5
		Bright dot defect	2
		Total Dot	5



	OUTGOING	G QUALITY STANDARD	PAGE 4 OF 5		
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA					
		1.Corner Fragment:	X X Y		
		Size(mm)	AcceptableQuantity		
3.2.5	Touch panel defect	X≤3mm Y≤3mm Z≤T	Ignore T: Glass thickness X: Length Y: Width Z: thickness		
		2. Side Fragment:			
		Size(mm)	Acceptable Quantity		
		X≤5.0mm Y ≤3mm Z≤T	Ignore T: Glass thickness X: Length Y: Width Z: thickness		
		Size $\varphi(mm)$	Acceptable Quantity		
3.2.6	Touch panel spot	φ≤0.25	Ignore		
		0.25 <φ≤0.5	4		
		0.5 < φ	0		



		Width(mm) Length(mm)	Acceptable Quantity
3.2.7	Touch panel White line	W≤0.03	Ignore
	Scratch	0.03 < W≤0.05 L≤5.0	4
		0.05 < W or L>5	Not allowed
3.2.8	Touch panel Newton ring	Compare with limit sample	
	50% of the dot an		f the dot area is larger than black and bright dot defects
	should be more		nce between two bright dot
	3. Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.		
	4. Mura is checker by	y 6% ND filter.	
	5. Foreign particle or	n the surface of the LCM shou	ld be ignore.



PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

(1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.

(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents

- Isopropyl alcohol

- Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.

- Water

- Ketone
- Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated



(13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist LCM.

Handling precaution for LCM

LCM is easy to be damaged. Please note below and be careful for handling!

Correct handling:



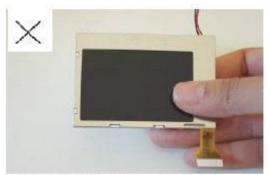


As above picture, please handle with anti-static gloves around LCM edges.

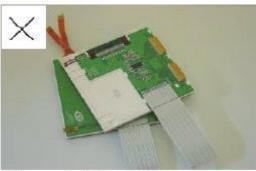
Incorrect handling:



Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.

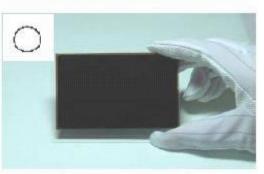


Handling precaution for LCD

LCD is easy to be damaged. Please note below and be careful for handling!

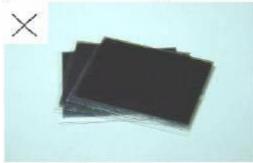
Correct handling:





As above photo, please handle with anti-static gloves around LCD edges.

Incorrect handling:



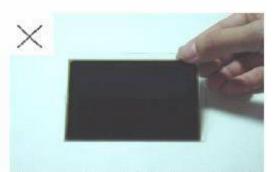
Please don't stack the LCDS.



Please don't hold the surface of LCD.



Please don't operate with sharp stick such as pens.



Please don't touch ITO glass without anti-static gloves.



Storage Precautions

When storing the LCD modules, the following precaution is necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the anti-static electricity container in which they were shipped. Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.

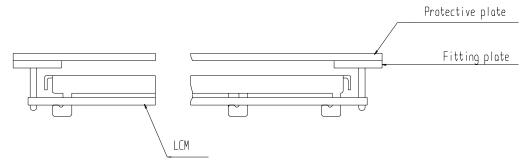
-Terminal electrode sections.

USING LCD MODULES

Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

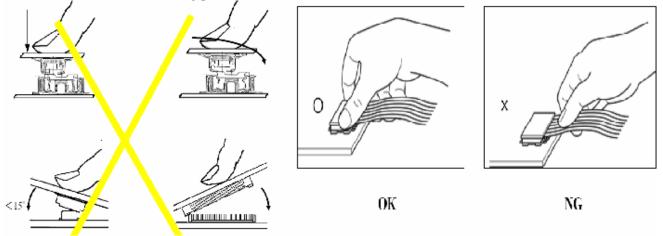
(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows







Precaution for soldering to the LCM

	Hand soldering	Machine drag soldering	Machine press soldering
No ROHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
product	Time : 3-5S.	Speed : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa
ROHS	340°C ∼370°C.	350°C ~370°C.	330°C ~360°C.
product	Time : 3-5S.	Time : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa

(1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

(2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

(3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

(1) Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.

(2) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

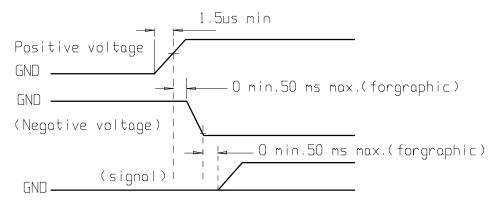
(3) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, Which will come back in the specified operating temperature.

(4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

(5) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature,50%RH or less is required.

(6) Input each signal after the positive/negative voltage becomes stable.

(7) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.





Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

Limited Warranty

Unless agreed betweenMulti-Inno and customer,Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability ofMulti-Inno limited to repair and/or replacement on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet is damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

PRIOR CONSULT MATTER

- 1. TFor Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without notice on our customer.
 - ⁽²⁾For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
- 2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.